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Product Change Notification - JAON-31FWIA899

Date: 09 Sep 2016
Product Category: Memory
Notification subject: CCB 2730 and 2730.001 Initial Notice: Qualification of HR-9004 die attach material for selected products available in 48L WFBGA (4x6x0.8mm) and 34L WFBGA (4x6x0.8mm) packages at LPI assembly site.
Notification text: **PCN Status:** Initial notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of HR-9004 die attach material for selected products available in 48L WFBGA (4x6x0.8mm) and 34L WFBGA (4x6x0.8mm) packages at LPI assembly site.

Pre Change:

Using EM-700J die attach material.

Post Change:

Using HR-9004 die attach material

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	LPI assembly site	LPI assembly site
Wire material	Au wire	Au wire
Die attach material	EM-700J	HR-9004
Molding compound material	G770HT	G770HT
Substrate material	BT Substrate	BT Substrate

Impacts to Data Sheet:
None

Change Impact:
None

Reason for Change:
To Improve On-Time Delivery Performance by qualifying HR-9004 die attach material. The EM-700J die attach material will no longer be available for use to assemble selected products available in 48L WFBGA (4x6x0.8mm) and 34L WFBGA (4x6x0.8mm) packages at LPI assembly site.

Change Implementation Status:
In Progress

Estimated Qualification Completion Date:
January 2017

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date.

Time Table Summary:

Workweek	September 2016					->	January 2017			
	35	36	37	38	39		01	02	03	04
Initial PCN Issue Date		X								
Qual Report Availability							X			
Final PCN Issue Date							X			

Method to Identify Change:
Traceability code

Qualification Plan:
Please open the attachments included with this PCN labeled as PCN_#_Qual Plan.

Revision History:
September 09, 2016: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

- Attachment(s):**
- [PCN_JAON-31FWIA899_Qual_Plan.pdf](#)
 - [PCN_JAON-31FWIA899_Affected_CPN.pdf](#)
 - [PCN_JAON-31FWIA899_Affected_CPN.xls](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

PCN_JAON-31FWIA899
CATALOG_PART_NBR
SST39LF010-45-4C-MME
SST39LF400A-55-4C-MAQE
SST39LF400A-55-4C-MAQE-T
SST39LF401C-55-4C-MAQE
SST39LF401C-55-4C-MAQE-T
SST39LF402C-55-4C-MAQE
SST39LF402C-55-4C-MAQE-T
SST39LF800A-55-4C-MAQE
SST39LF800A-55-4C-MAQE-T
SST39LF801C-55-4C-MAQE
SST39LF801C-55-4C-MAQE-T
SST39LF802C-55-4C-MAQE
SST39LF802C-55-4C-MAQE-T
SST39VF1601C-70-4C-MAQE
SST39VF1601C-70-4I-MAQE
SST39VF1601C-70-4I-MAQE-DCS
SST39VF1602C-70-4C-MAQE
SST39VF1602C-70-4I-MAQE
SST39VF1602C-70-4I-MAQE-DCS
SST39VF200A-70-4C-MAQE
SST39VF200A-70-4C-MAQE-T
SST39VF200A-70-4I-MAQE
SST39VF200A-70-4I-MAQE-T
SST39VF400A-70-4C-MAQE
SST39VF400A-70-4C-MAQE-T
SST39VF400A-70-4I-MAQE
SST39VF400A-70-4I-MAQE-T
SST39VF401C-70-4C-MAQE
SST39VF401C-70-4C-MAQE-T
SST39VF401C-70-4I-MAQE
SST39VF401C-70-4I-MAQE-T
SST39VF402C-70-4C-MAQE
SST39VF402C-70-4C-MAQE-T
SST39VF402C-70-4I-MAQE
SST39VF402C-70-4I-MAQE-T
SST39VF800A-70-4C-MAQE
SST39VF800A-70-4C-MAQE-T
SST39VF800A-70-4I-MAQE
SST39VF800A-70-4I-MAQE-T
SST39VF801C-70-4C-MAQE
SST39VF801C-70-4C-MAQE-T
SST39VF801C-70-4I-MAQE
SST39VF801C-70-4I-MAQE-DCS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-31FWIA899
CATALOG_PART_NBR
SST39VF801C-70-4I-MAQE-DCS-T
SST39VF801C-70-4I-MAQE-T
SST39VF802C-70-4C-MAQE
SST39VF802C-70-4C-MAQE-T
SST39VF802C-70-4I-MAQE
SST39VF802C-70-4I-MAQE-DCS
SST39VF802C-70-4I-MAQE-DCS-T
SST39VF802C-70-4I-MAQE-T
SST39WF1601-70-4C-MAQE
SST39WF1601-70-4C-MAQE-T
SST39WF1601-70-4I-MAQE
SST39WF1601-70-4I-MAQE-MQ1
SST39WF1601-70-4I-MAQE-MQ1-T
SST39WF1601-70-4I-MAQE-PP013
SST39WF1601-70-4I-MAQE-PP013-T
SST39WF1601-70-4I-MAQE-T
SST39WF1602-70-4C-MAQE
SST39WF1602-70-4C-MAQE-T
SST39WF1602-70-4I-MAQE
SST39WF1602-70-4I-MAQE-MQ2
SST39WF1602-70-4I-MAQE-MQ2-T
SST39WF1602-70-4I-MAQE-T
SST39WF400B-70-4C-MAQE
SST39WF400B-70-4C-MAQE-T
SST39WF400B-70-4I-MAQE
SST39WF400B-70-4I-MAQE-T
SST39WF800B-70-4C-MAQE
SST39WF800B-70-4C-MAQE-T
SST39WF800B-70-4I-MAQE
SST39WF800B-70-4I-MAQE-T